

QT-Brightek Chip LED Series

SMD 1205 LED

Part No.: QBLP655 series

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Introduction

Feature:

- Water clear lens
- Package in tape and reel
- Ultra bright 1205 package
- InGaN technology for IB/IG/IW
- AlInGaP technology for R/AG/ Y/O
- Viewing angle: 140 degrees

Description:

These ultra-bright 655 LEDs have a height profile of 1.10mm. With a combination of high brightness output and small footprint, these LEDs are ideal for keypad backlighting and status indication.

Application:

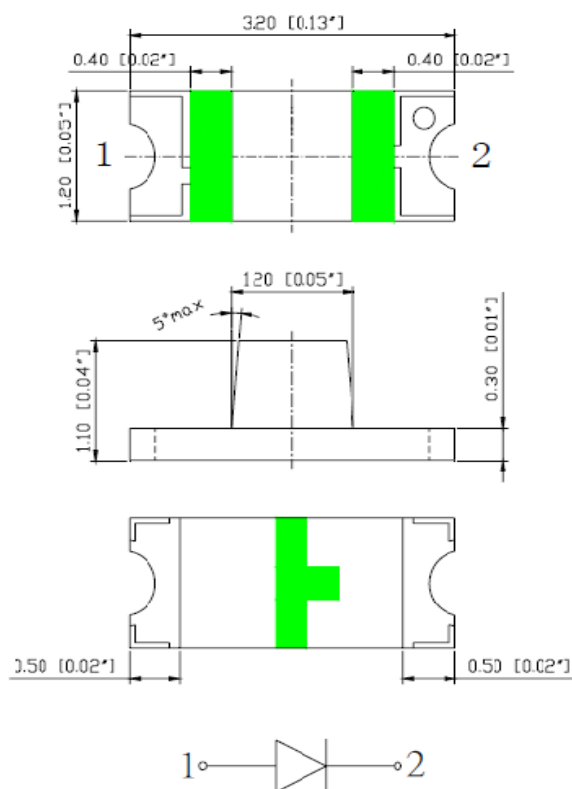
- Status indication
- Back lighting application

Certification & Compliance:

- TS16949
- ISO9001
- RoHS Compliant



Dimension:



Units: mm / tolerance = +/-0.1mm

Electrical / Optical Characteristic (Ta=25 °C)

Product	Color	I _F (mA)	V _F (V)		λ _D (nm)			I _V (mcd)	
			Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.
QBLP655-IB	Blue	20	3.1	3.7	465	470	475	32	60
QBLP655-IG	True Green	20	3.1	3.7	515	520	525	200	330
QBLP655-IW	White	20	3.1	3.7	-	X=0.29 Y=0.28	-	100	180
QBLP655-R	Red	20	2.0	2.4	615	625	630	63	100
QBLP655-AG	Yellow Green	20	2.0	2.5	565	570	576	16	25
QBLP655-Y	Yellow	20	2.0	2.5	585	590	595	40	65
QBLP655-O	Orange	20	2.0	2.5	600	605	610	63	100

Absolute Maximum Rating

Material	P _d (mW)	I _F (mA)	I _{FP} (mA)*	V _R (V)	T _{OP} (°C)	T _{ST} (°C)	T _{SOL} (°C)**
InGaN (IB/IG/IW)	120	30	125	5	-40 ~ +85	-40 ~ +100	260
AlInGaP (R/AG/Y/O)	75	30	125	5	-40 ~ +85	-40 ~ +100	260

*Duty 1/8 @ 1KHz

** IR Reflow for no more than 10 sec @ 260 °C

Forward Voltage V_F for AlInGaP @ I_F=20mA

Bin	Min.	Max.	Unit
□	1.7	2.5	V

Forward Voltage V_F for InGaN @ I_F=20mA

Bin	Min.	Max.	Unit
f	2.8	3.1	V
g	3.1	3.4	
h	3.4	3.7	

Luminous Intensity I_V @ $I_F=20mA$

Bin	Min.	Max.	Unit
B	16	20	mcd
C	20	25	
D	25	32	
E	32	40	
F	40	50	
G	50	63	
H	63	80	
I	80	100	
J	100	125	
K	125	160	
L	160	200	
M	200	250	
N	250	320	
O	320	400	
P	400	500	
Q	500	630	

Dominant Wavelength λ_D for Blue @ $I_F=20mA$

Bin	Min.	Max.	Unit
G	465	467.5	nm
H	467.5	470	
I	470	472.5	
J	472.5	475	

Dominant Wavelength λ_D for Green @ $I_F=20mA$

Bin	Min.	Max.	Unit
S	515	517.5	nm
T	517.5	520	
U	520	522.5	
V	522.5	525	

Dominant Wavelength λ_D for Red @ $I_F=20mA$

Bin	Min.	Max.	Unit
s	615	620	nm
t	620	625	
u	625	630	

Dominant Wavelength λ_D for Yellow Green @ $I_F=20\text{mA}$

Bin	Min.	Max.	Unit
h	565	568	nm
i	568	572	
j	572	576	

Dominant Wavelength λ_D for Yellow @ $I_F=20\text{mA}$

Bin	Min.	Max.	Unit
m	585	590	nm
n	590	595	

Dominant Wavelength λ_D for Orange @ $I_F=20\text{mA}$

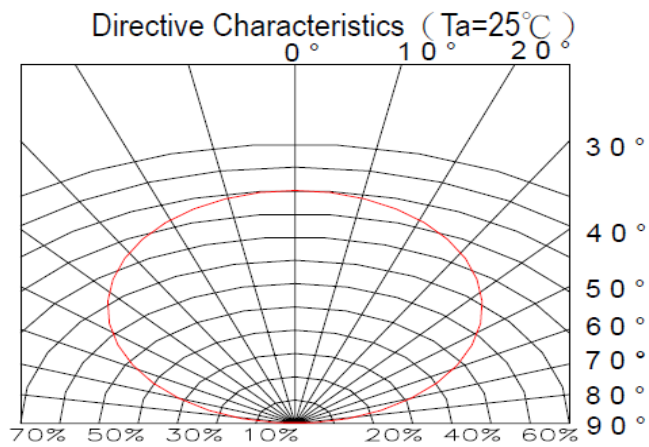
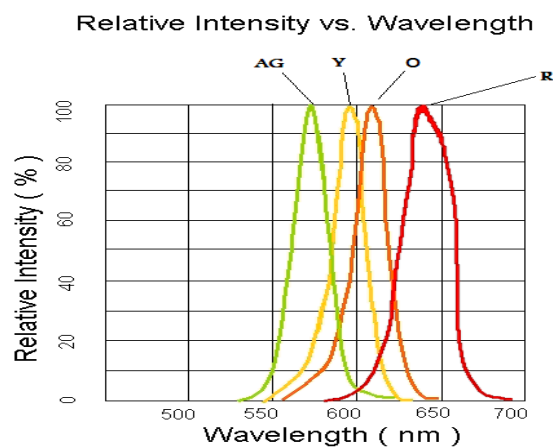
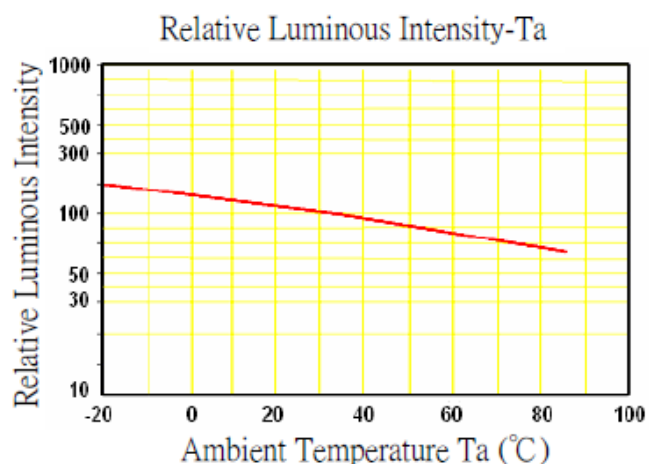
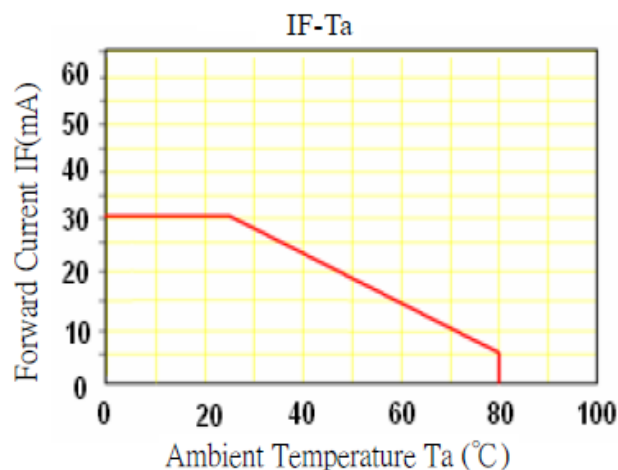
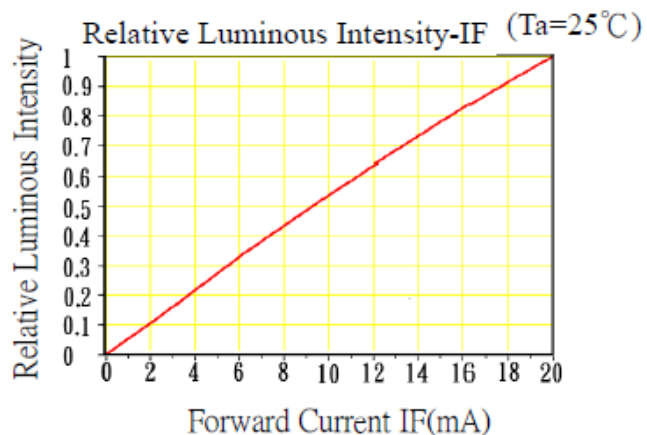
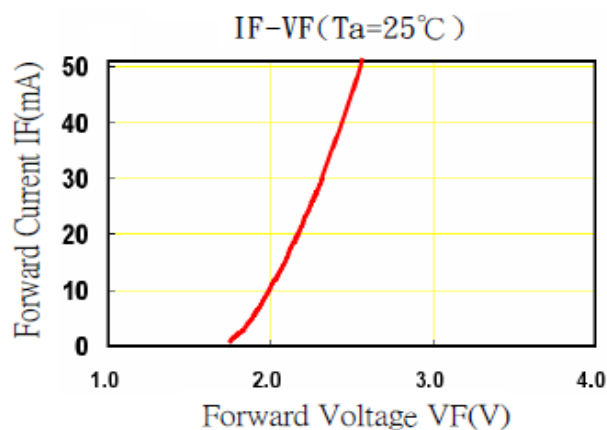
Bin	Min.	Max.	Unit
p	600	605	nm
q	605	610	

Chromaticity Coordinates for White @ $I_F=20\text{mA}$

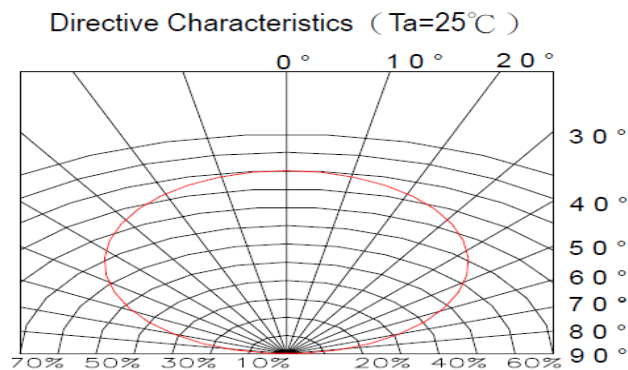
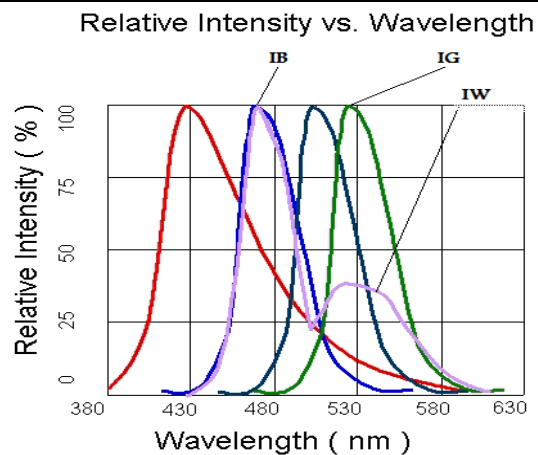
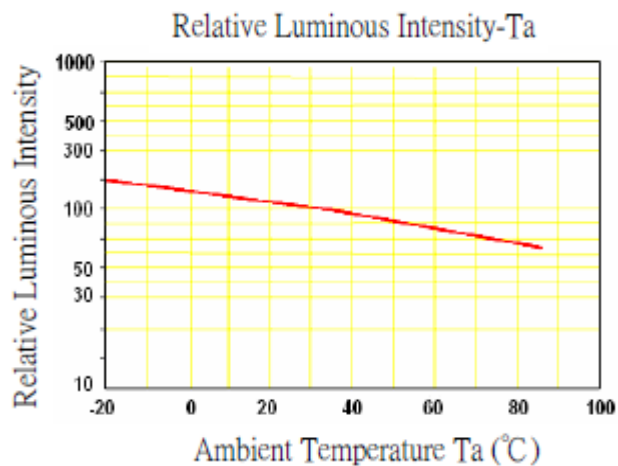
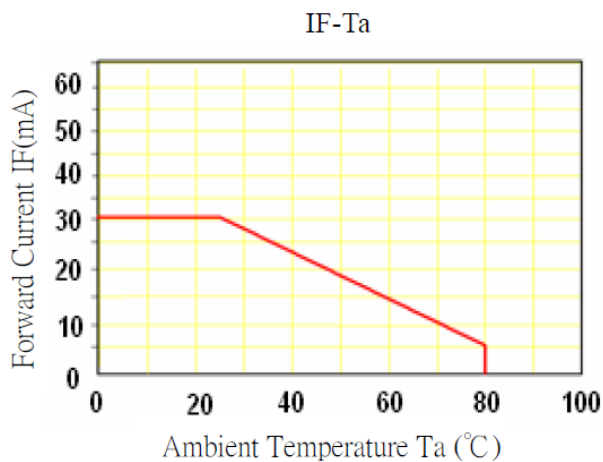
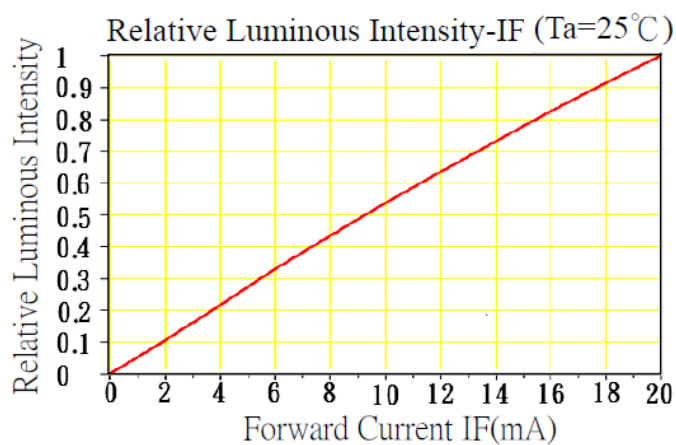
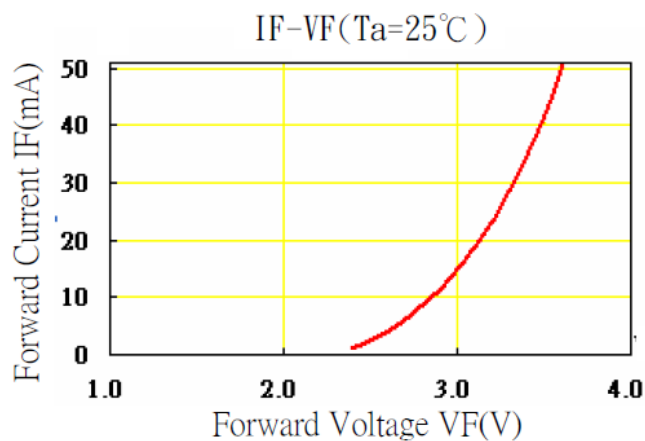
Rank	Chromaticity coordinates				
C1	X	0.2500	0.2700	0.2700	0.2500
	Y	0.2500	0.2775	0.2325	0.2050
C2	X	0.2700	0.2900	0.2900	0.2700
	Y	0.2775	0.3050	0.2600	0.2325
D1	X	0.2900	0.3100	0.3100	0.2900
	Y	0.3050	0.3325	0.2875	0.2600
D2	X	0.3100	0.3300	0.3300	0.3100
	Y	0.3325	0.3600	0.3150	0.2875

Characteristic Curves

AllnGaP (R/AG/Y/O)

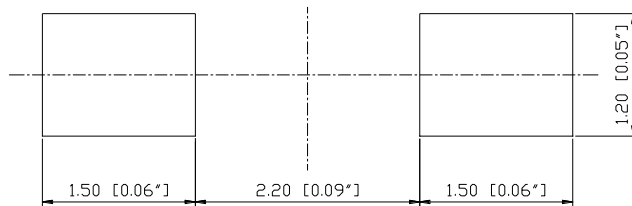
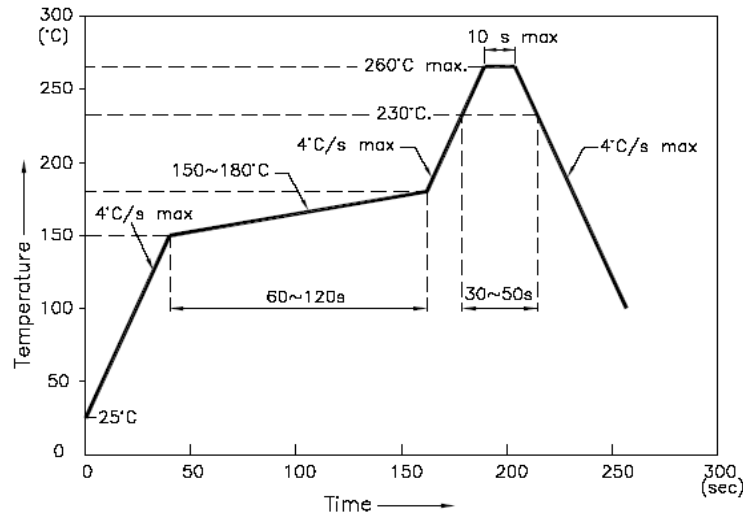


InGaN (IB/IG/IW)



Solder Profile & Footprint

- Recommended tin solder specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

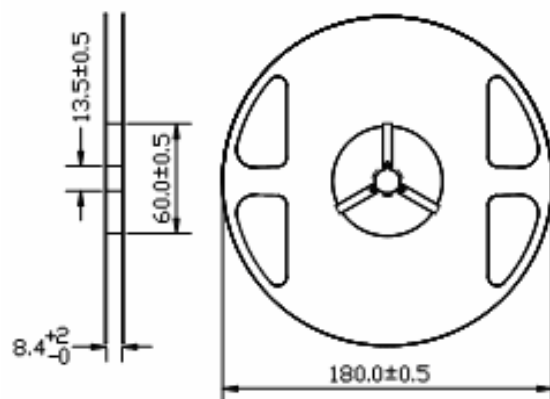


Units: mm

tolerance: +/- 0.1mm

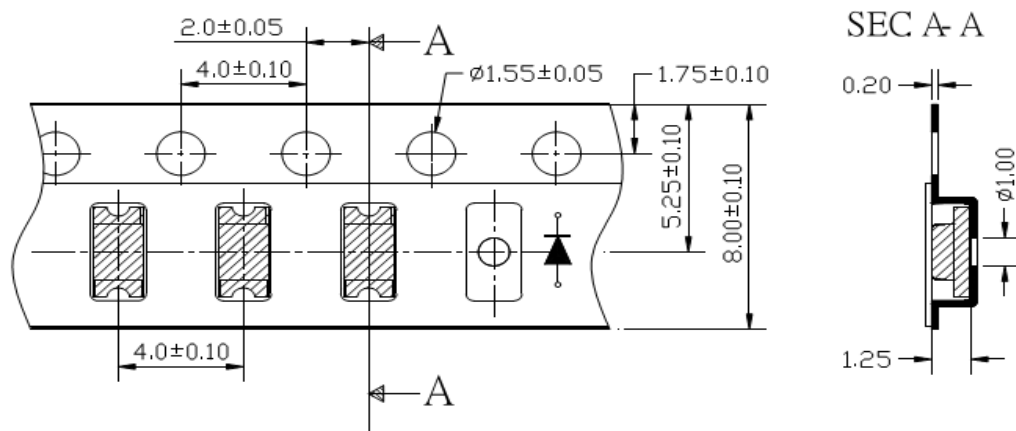
Packing

Reel Dimension:



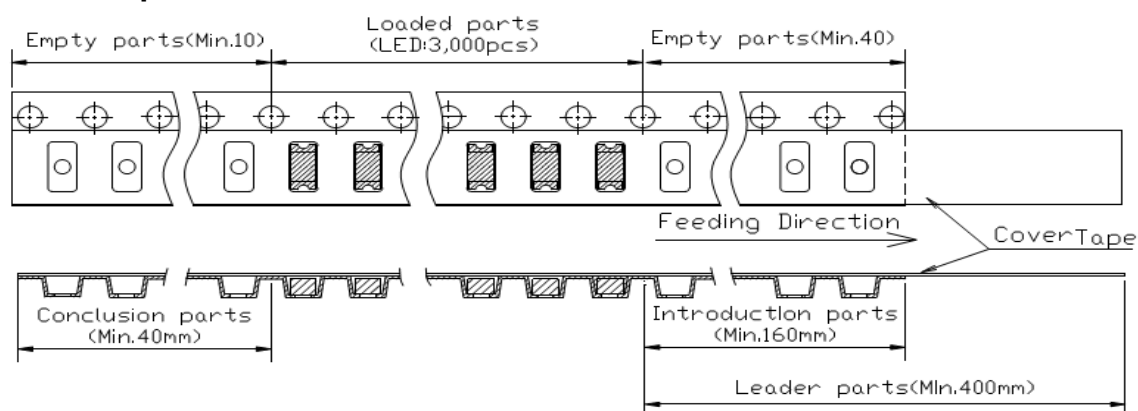
Unit: mm

Tape Dimension:

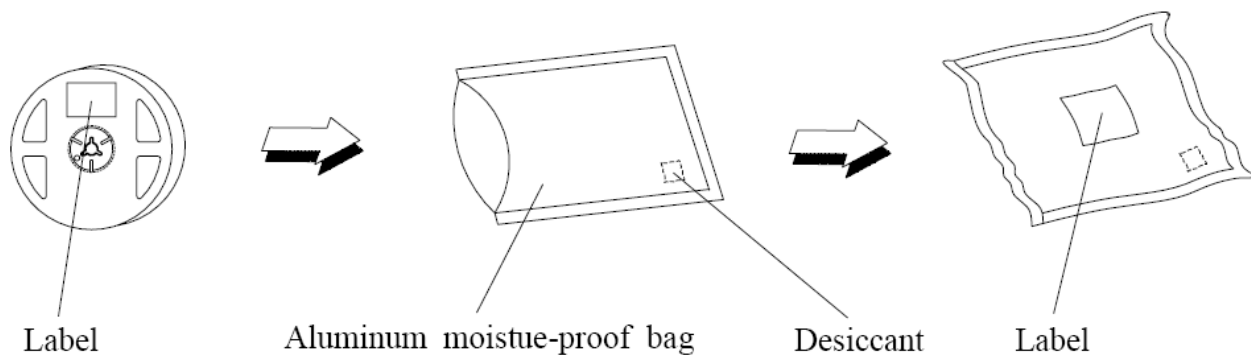


Unit: mm

Arrangement of Tape:



Packaging Specifications:



Labeling



Part No: _____

Customer P/N: _____

Item: _____

Q'ty: _____

Vf: _____

Iv: _____

WI: _____

Date: _____

Made in China

Ordering Information

Part #	Orderable Part #	Spec Range	Quantity per reel
QBLP655-IB	QBLP655-IB	Iv = 60 mcd Typ. / Color = 465-475nm	3,000 units
QBLP655-IG	QBLP655-IG	Iv = 330 mcd Typ. / Color = 515-525nm	3,000 units
QBLP655-IW	QBLP655-IW	Iv = 180 mcd Typ. / X=0.29, Y=0.28	3,000 units
QBLP655-R	QBLP655-R	Iv = 100 mcd Typ. / Color = 615-630nm	3,000 units
QBLP655-AG	QBLP655-AG	Iv = 25 mcd Typ. / Color = 565-576nm	3,000 units
QBLP655-Y	QBLP655-Y	Iv = 65 mcd Typ. / Color = 585-595nm	3,000 units
QBLP655-O	QBLP655-O	Iv=120 mcd Typ./ Color = 600-610nm	3,000 units

Revision History

Description:	Revision #	Revision Date
New Release of QBLP655 series	V1.0	08/15/2011
Add bin code/ amend pad layout	V1.1	01/13/2012
Update to new format	V2.0	06/04/2012
Update spec	V2.1	03/27/2014

Disclaimer

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.